



flowPIM 0 + PFC

600 V / 20 A

Topology features

- Open Emitter configuration
- Temperature sensor
- Converter+PFC+Inverter
- Integrated Shunt Resistor

Component features

- Highest efficiency in hard switching and resonant topologies
- Lowest switching losses
- Optimized for ultra-fast switching

Housing features

- Base isolation: Al₂O₃
- Clip-in, reliable mechanical connection, qualified for wave soldering
- Convex shaped substrate for superior thermal contact
- Thermo-mechanical push-and-pull force relief
- Press-fit pin
- Reliable cold welding connection

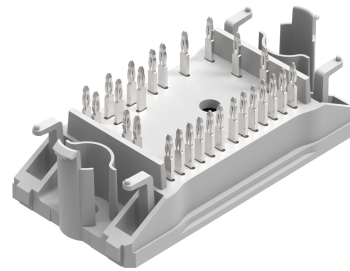
Target applications

- Embedded Drives
- Industrial Drives

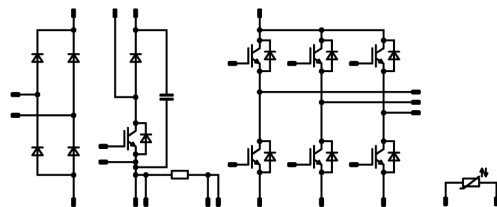
Types

- 10-P006PPA020SB02-M685B30Y

flow 0 17 mm housing



Schematic





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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	24	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	53	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 360\text{ V}$ $T_j = 150\text{ °C}$	6	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Inverter Diode				
Peak repetitive reverse voltage	V_{RRM}		600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	32	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	52	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

PFC Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	44	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	72	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
PFC Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	46	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	63	W
Maximum junction temperature	T_{jmax}		175	°C

PFC Sw. Inverse Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s \leq 80\text{ °C}$	12 ⁽¹⁾	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	12	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	36	W
Maximum junction temperature	T_{jmax}		175	°C

⁽¹⁾ limited by I_{FRM}

Rectifier Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	33	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	200	A
Surge current capability	$\hat{I}t$		200	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	44	W
Maximum junction temperature	T_{jmax}		150	°C

PFC Shunt

DC current	I		27,1	A
Power dissipation	P_{tot}	$T_c = 70\text{ °C}$	5	W
Operation Temperature	T_{op}		-55 ... 170	°C



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datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Capacitor (PFC)				
Maximum DC voltage	V_{MAX}		500	V
Operation Temperature	T_{op}		-55 ... 125	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			>12,7	mm
Comparative Tracking Index	CTI		≥ 200	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00029	25	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		20	25 150	1,1	1,53 1,85	1,9 ⁽²⁾	V
Collector-emitter cut-off current	I_{CES}		0	600		25			1,1	μA
Gate-emitter leakage current	I_{GES}		20	0		25			300	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}							1100		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25		71		pF
Reverse transfer capacitance	C_{res}							32		pF
Gate charge	Q_g	$V_{CC} = 480$ V	0/15		20	25		120		nC

Thermal

Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,81		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 16$ Ω $R_{goff} = 16$ Ω	±15	400	15	25		65,6		ns
						125		65,2		
Rise time	t_r					25		19,8		
						125		21		
Turn-off delay time	$t_{d(off)}$					25		141,8		
						125		167		
Fall time	t_f					25		76,33		
		125		86,36						
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 0,883$ μC				25		0,45		mWs
		$Q_{tFWD} = 1,79$ μC				125		0,667		
Turn-off energy (per pulse)	E_{off}					25		0,385		mWs
						125		0,523		



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Inverter Diode

Static

Forward voltage	V_F				30	25 125	1,25	1,65 1,62	1,95 ⁽²⁾	V
Reverse leakage current	I_R	$V_r = 600$ V				25			27	μA

Thermal

Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,81		K/W
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Dynamic

Peak recovery current	I_{RM}	$di/dt=731$ A/μs $di/dt=708$ A/μs	±15	400	15	25		10,06		A
						125		13,55		
Reverse recovery time	t_{rr}					25		173,99		
						125		233,08		
Recovered charge	Q_r					25		0,883		
						125		1,79		
Reverse recovered energy	E_{rec}	25		0,236						
		125		0,474						
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	25		36,18						
		125		85,35						



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

PFC Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0005	25	3,3	4	4,7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		50	25 125 150		1,52 1,64 1,7	2,22 ⁽²⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			40	μA
Gate-emitter leakage current	I_{GES}		20	0		25			120	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}							3000		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25		50		pF
Reverse transfer capacitance	C_{res}							11		pF
Gate charge	Q_g	$V_{CC} = 520$ V	15		50	25		120		nC

Thermal

Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,32		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		19,2 19,2 19,04		ns
Rise time	t_r					25 125 150		9,76 11,04 11,52		ns
Turn-off delay time	$t_{d(off)}$		0/15	400	50	25 125 150		87,36 103,52 107,68		ns
Fall time	t_f					25 125 150		5 4,22 4,39		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 1,66$ μC $Q_{tFWD} = 3,14$ μC $Q_{tFWD} = 3,57$ μC				25 125 150		0,365 0,58 0,624		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,364 0,476 0,518		mWs



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datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
PFC Diode										
Static										
Forward voltage	V_F			50	25 125 150		1,5 1,44 1,42	1,92 ⁽²⁾		V
Reverse leakage current	I_R	$V_T = 650$ V			25			2,65		μA
Thermal										
Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)					1,5			K/W
Dynamic										
Peak recovery current	I_{RM}				25 125 150		56,36 70,28 74,71			A
Reverse recovery time	t_{rr}				25 125 150		47,37 78,83 87,49			ns
Recovered charge	Q_r	$di/dt=4427$ A/μs $di/dt=4057$ A/μs $di/dt=4001$ A/μs	0/15	400	50	25 125 150	1,66 3,14 3,57			μC
Reverse recovered energy	E_{rec}				25 125 150		0,555 1,02 1,17			mWs
Peak rate of fall of recovery current	$(di_r/dt)_{max}$				25 125 150		1599 1123 1211			A/μs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	

PFC Sw. Inverse Diode

Static

Forward voltage	V_F				6	25 125 150	1,23	1,72 1,58 1,54	1,87 ⁽²⁾	V
Reverse leakage current	I_R	$V_r = 650$ V				25			0,1	μA

Thermal

Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,65		K/W
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Rectifier Diode

Static

Forward voltage	V_F				8	25 125		0,996 0,907	1,21 ⁽²⁾ 1,1 ⁽²⁾	V
Reverse leakage current	I_R	$V_r = 1600$ V				25 150			100 1000	μA

Thermal

Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,59		K/W
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PFC Shunt

Static

Resistance	R							6,8		mΩ
Tolerance							-1		1	%
Temperature coefficient	tc								100	ppm/K



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Capacitor (PFC)

Static

Capacitance	C	DC bias voltage = 0 V				25		100		nF
Tolerance							-10		10	%
Dissipation factor		$f = 1$ kHz				25		2,5		%

Thermistor

Static

Rated resistance	R					25		22		k Ω
Deviation of R100	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ± 1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ± 1 %						4000		K
Vincotech Thermistor Reference									I	

(2) Value at chip level

(3) Only valid with pre-applied Vincotech thermal interface material.

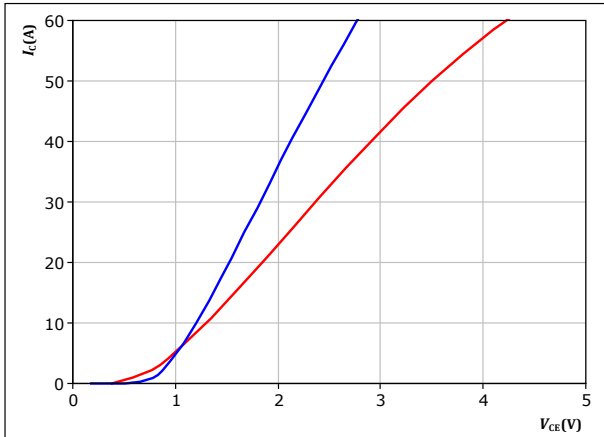


Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

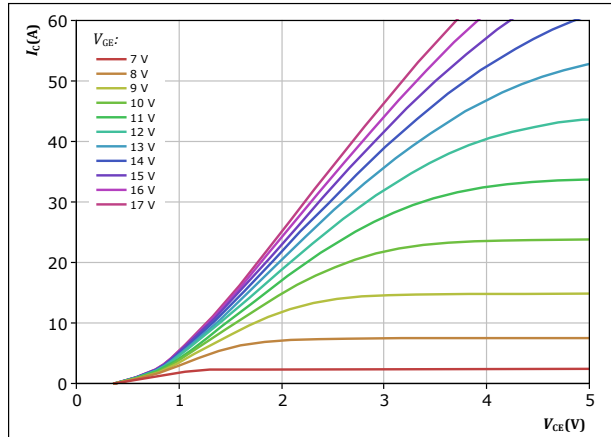


$t_p = 250 \mu\text{s}$
 $V_{GE} = 15 \text{ V}$
 $T_j: 25^\circ\text{C}$ (blue), 150°C (red)

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

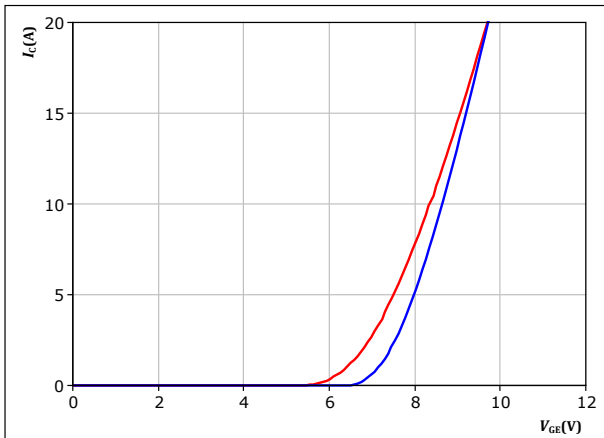


$t_p = 250 \mu\text{s}$
 $T_j = 150^\circ\text{C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

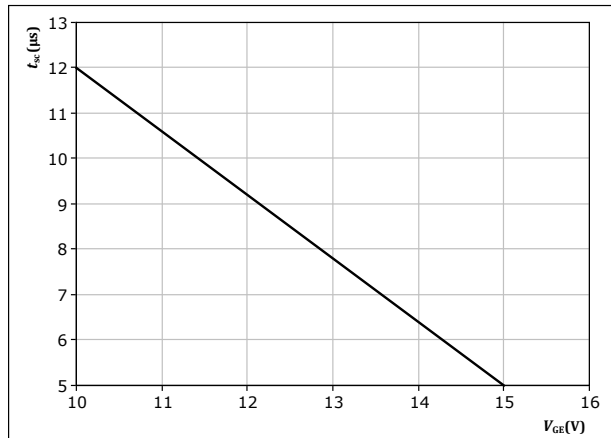


$t_p = 250 \mu\text{s}$
 $V_{CE} = 10 \text{ V}$
 $T_j: 25^\circ\text{C}$ (blue), 150°C (red)

figure 4. IGBT

Short circuit withstand time as a function of V_{GE}

$$t_{sc} = f(V_{GE})$$



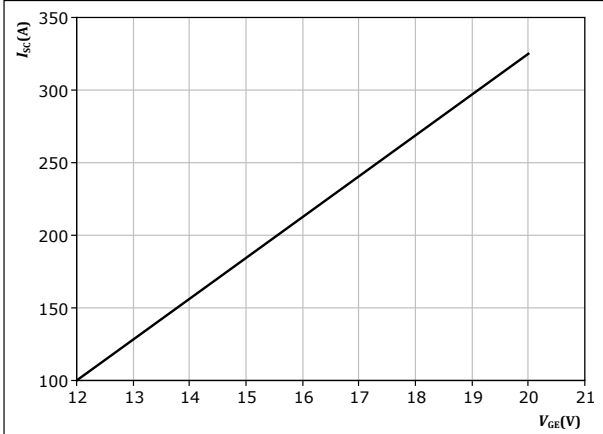
At $V_{CE} = 333 \text{ V}$
 $T_j \leq 333^\circ\text{C}$



Inverter Switch Characteristics

figure 5. IGBT

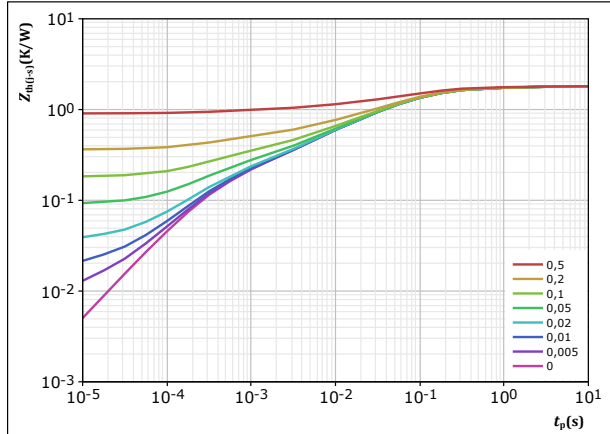
Typical short circuit current as a function of V_{GE}
 $I_{SC} = f(V_{GE})$



At $V_{CE} = 333$ V
 $T_j \leq 333$ °C

figure 6. IGBT

Transient thermal impedance as a function of pulse width
 $Z_{th(j-s)} = f(t_p)$

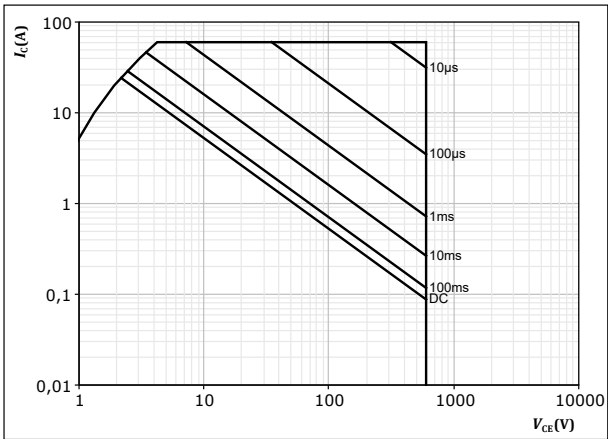


$D = t_p / T$
 $R_{th(j-s)} = 1,808$ K/W
IGBT thermal model values

R (K/W)	τ (s)
6,63E-02	3,68E+00
1,83E-01	4,61E-01
8,24E-01	8,38E-02
3,93E-01	1,82E-02
1,96E-01	3,57E-03
1,49E-01	3,52E-04

figure 7. IGBT

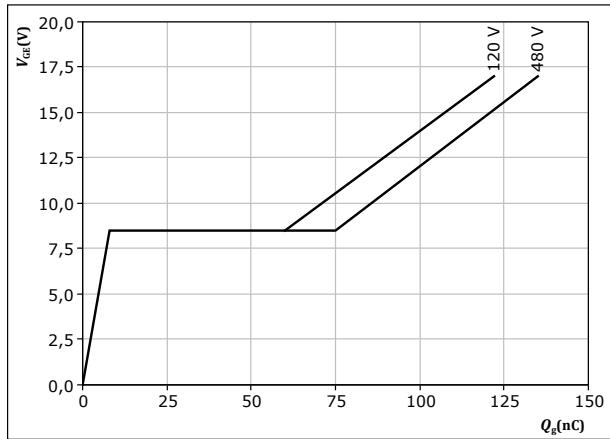
Safe operating area
 $I_C = f(V_{CE})$



$D =$ single pulse
 $T_j = 80$ °C
 $V_{GE} = 15$ V
 $T_j = T_{jmax}$

figure 8. IGBT

Gate voltage vs gate charge
 $V_{GE} = f(Q_g)$



$I_C = 33$ A
 $T_j = 25$ °C

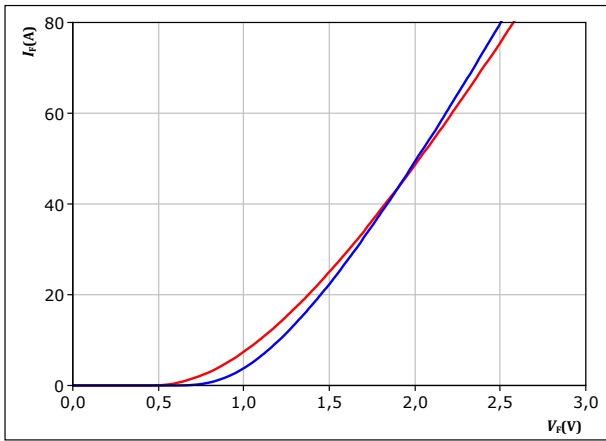


Inverter Diode Characteristics

figure 9. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

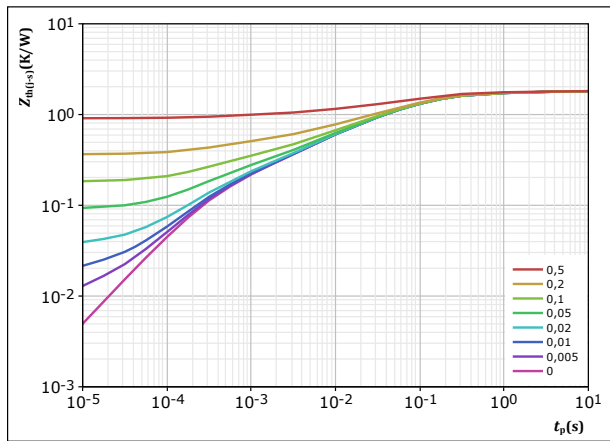


$t_p = 250 \mu s$
 $T_j: \text{ — } 25 \text{ }^\circ\text{C}$
 $\text{ — } 125 \text{ }^\circ\text{C}$

figure 10. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,811 \text{ K/W}$
FWD thermal model values

R (K/W)	τ (s)
8,35E-02	4,59E+00
2,01E-01	4,81E-01
7,60E-01	9,25E-02
4,22E-01	1,80E-02
2,13E-01	3,31E-03
1,40E-01	3,46E-04

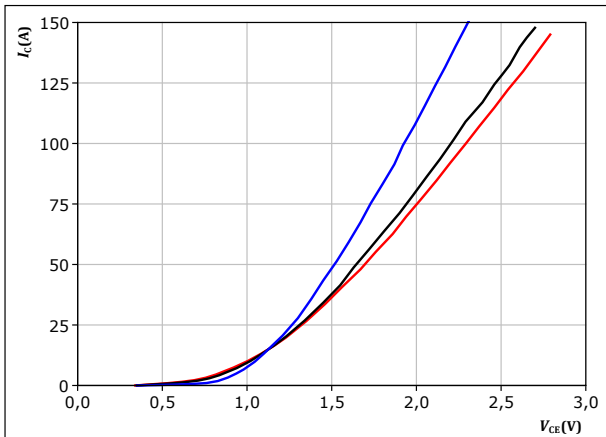


PFC Switch Characteristics

figure 11. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

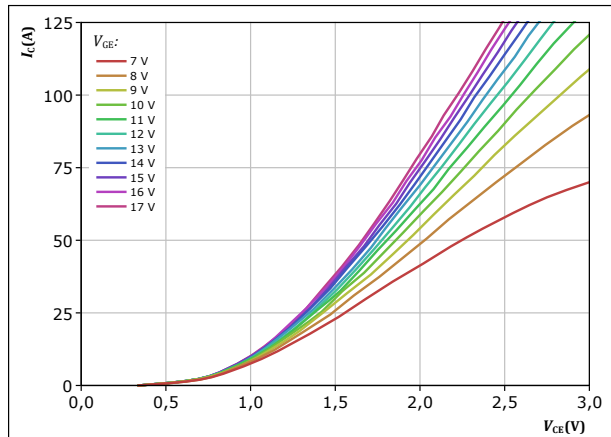


$t_p = 250\ \mu\text{s}$
 $V_{GE} = 15\ \text{V}$
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 12. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

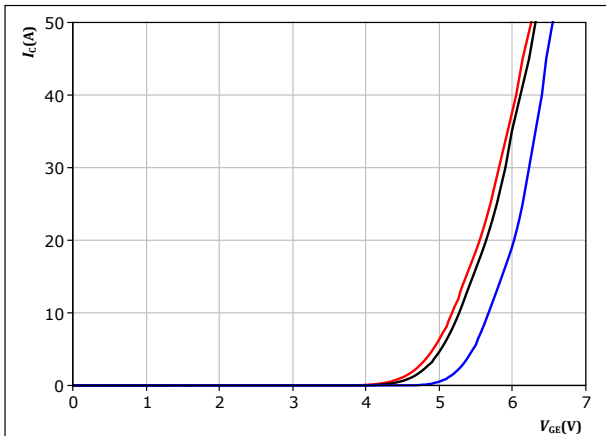


$t_p = 250\ \mu\text{s}$
 $T_j = 150\text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 13. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

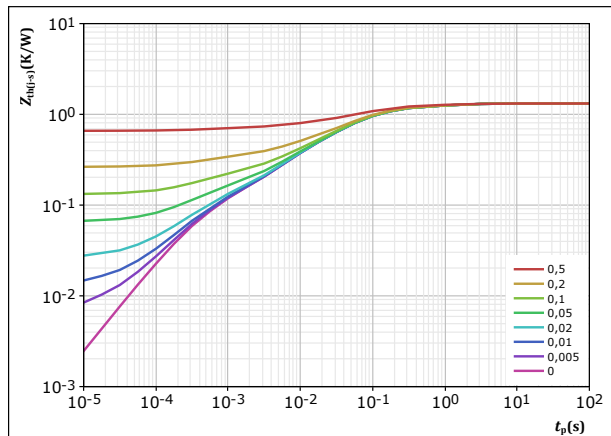


$t_p = 250\ \mu\text{s}$
 $V_{CE} = 10\ \text{V}$
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 14. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,316\ \text{K/W}$
IGBT thermal model values

R (K/W)	τ (s)
1,31E-01	1,38E+00
4,26E-01	1,35E-01
5,06E-01	3,67E-02
1,72E-01	5,83E-03
8,20E-02	4,05E-04

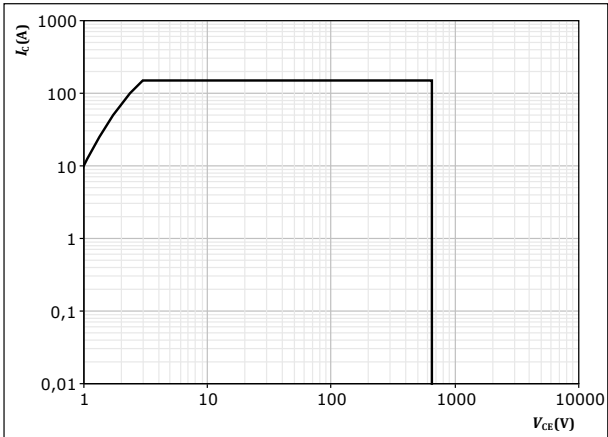


PFC Switch Characteristics

figure 15. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse

T_s = 80 °C

V_{CE} = 15 V

T_j = T_{jmax}



PFC Diode Characteristics

figure 16. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

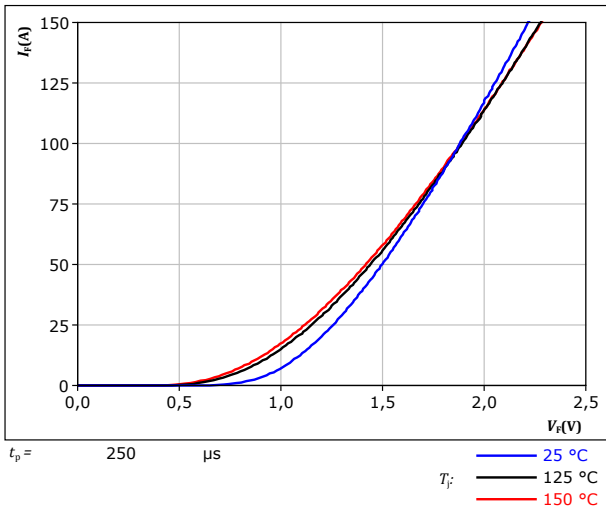
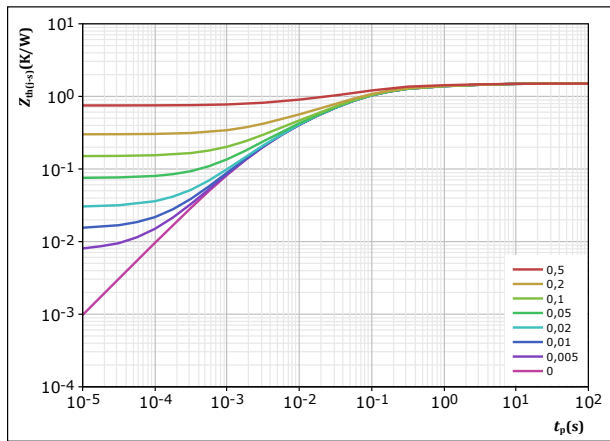


figure 17. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,501 \text{ K/W}$
 FWD thermal model values

R (K/W)	τ (s)
1,03E-01	4,73E+00
2,05E-01	5,53E-01
6,39E-01	8,31E-02
3,39E-01	2,02E-02
1,71E-01	4,42E-03
4,45E-02	1,30E-03



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PFC Sw. Inverse Diode Characteristics

figure 18. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

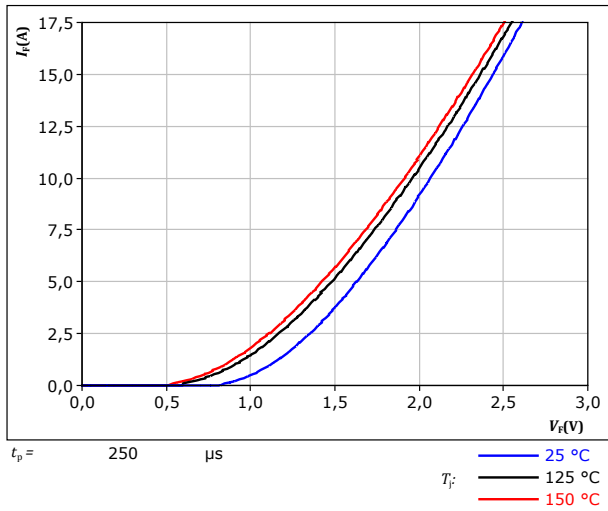
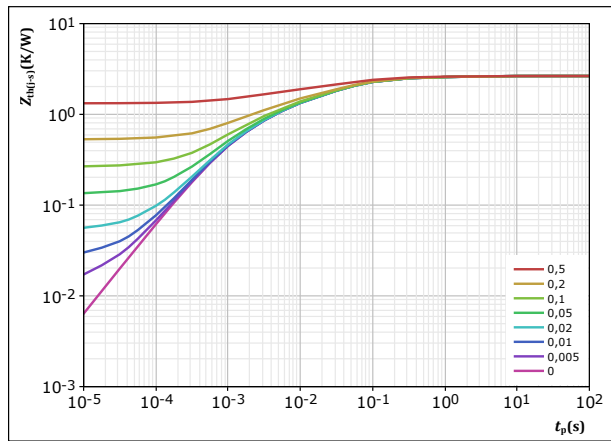


figure 19. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	2,646	K/W
FWD thermal model values		
R (K/W)	τ (s)	
1,02E-01	2,56E+00	
3,50E-01	1,72E-01	
9,53E-01	3,96E-02	
7,66E-01	5,83E-03	
4,76E-01	9,87E-04	



Rectifier Diode Characteristics

figure 20. Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$

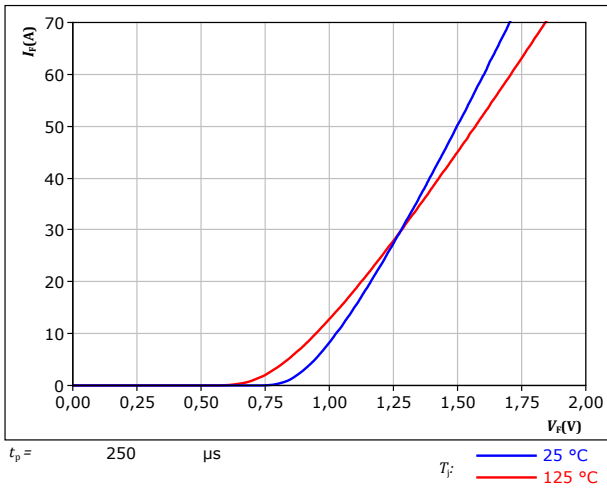
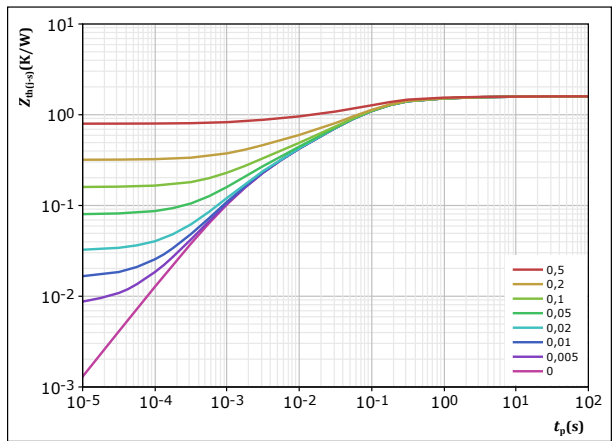


figure 21. Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = \frac{t_p}{T}$
 $R_{th(j-s)} = 1,594 \text{ K/W}$

Rectifier thermal model values

R (K/W)	τ (s)
3,44E-02	9,66E+00
1,12E-01	1,22E+00
5,81E-01	1,45E-01
4,89E-01	5,05E-02
2,38E-01	9,26E-03
1,22E-01	1,79E-03
1,81E-02	7,88E-04

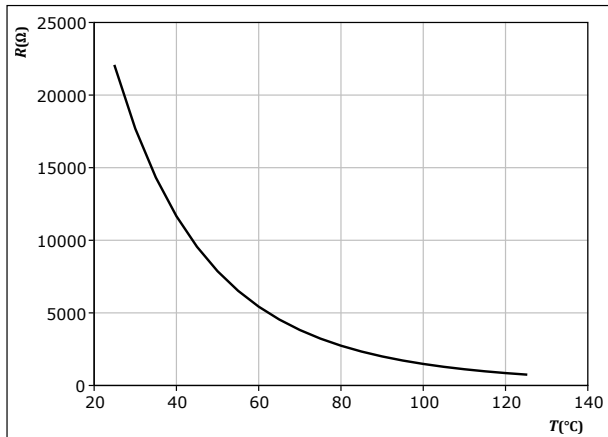


Thermistor Characteristics

figure 22. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

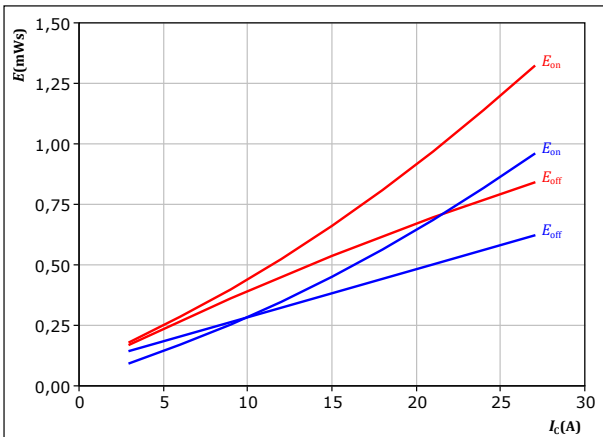




Inverter Switching Characteristics

figure 23. IGBT

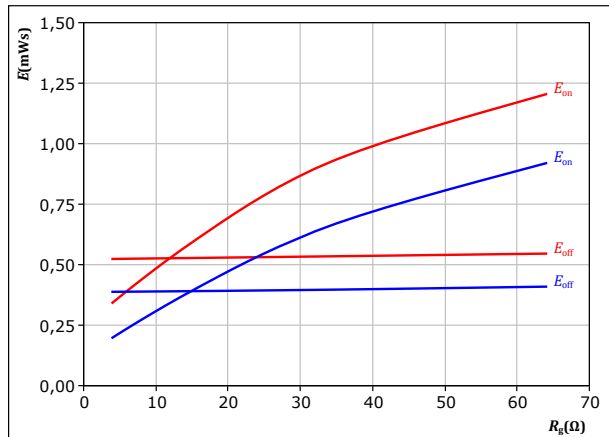
Typical switching energy losses as a function of collector current
 $E = f(I_c)$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{g\text{on}} = 16 \text{ } \Omega$
 $R_{g\text{off}} = 16 \text{ } \Omega$
 T_j : — 25 °C
 — 125 °C

figure 24. IGBT

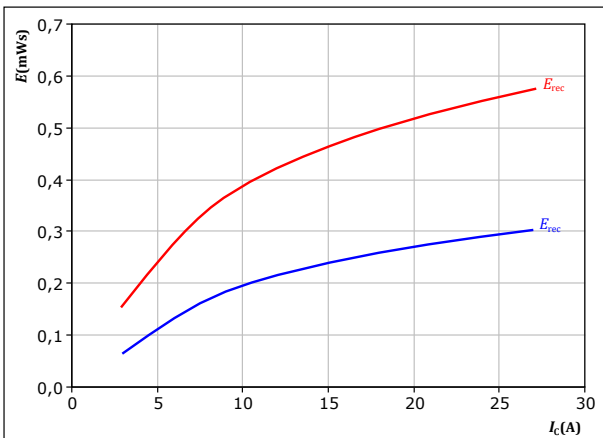
Typical switching energy losses as a function of IGBT turn on gate resistor
 $E = f(R_g)$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 15 \text{ A}$
 T_j : — 25 °C
 — 125 °C

figure 25. FWD

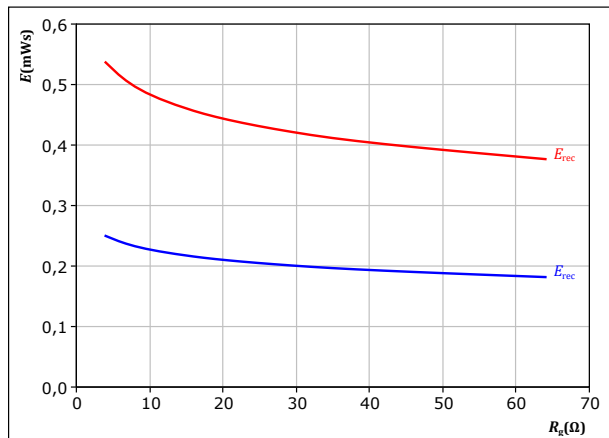
Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{g\text{on}} = 16 \text{ } \Omega$
 T_j : — 25 °C
 — 125 °C

figure 26. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor
 $E_{rec} = f(R_g)$



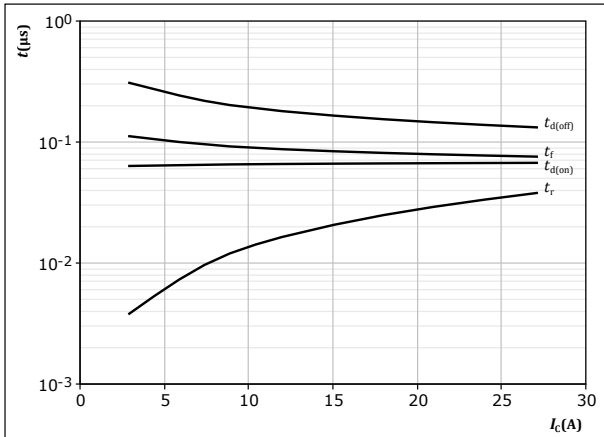
With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 15 \text{ A}$
 T_j : — 25 °C
 — 125 °C



Inverter Switching Characteristics

figure 27. IGBT

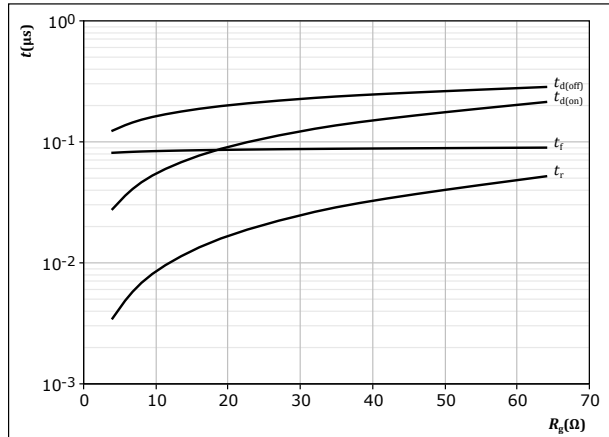
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 125 \text{ } ^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 16 \text{ } \Omega$
 $R_{goff} = 16 \text{ } \Omega$

figure 28. IGBT

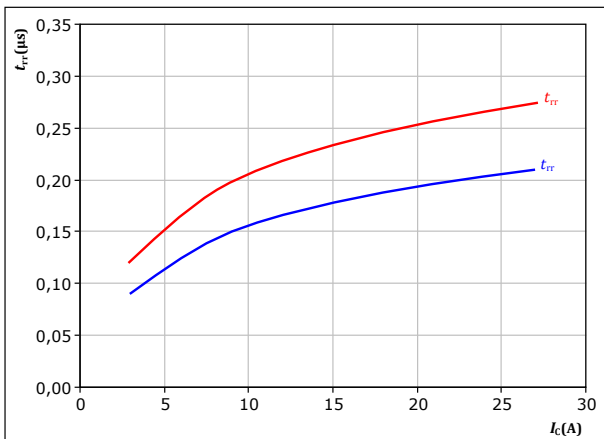
Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 125 \text{ } ^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 15 \text{ A}$

figure 29. FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$

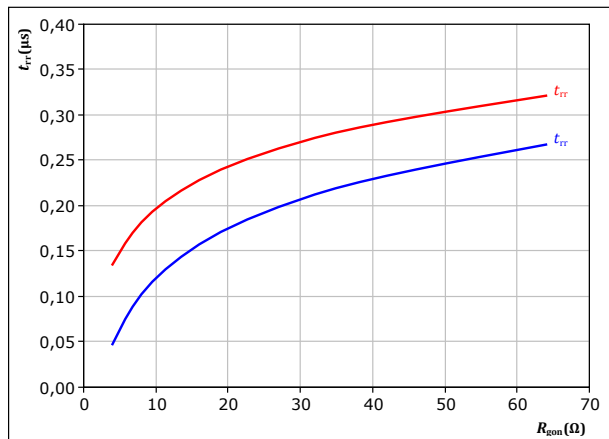


With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 16 \text{ } \Omega$

T_j : — 25 °C
 — 125 °C

figure 30. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 15 \text{ A}$

T_j : — 25 °C
 — 125 °C

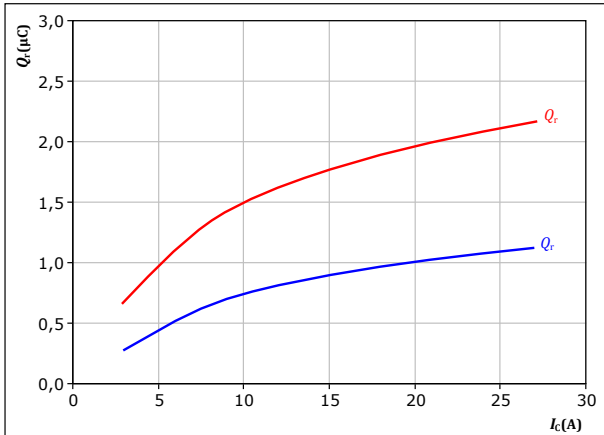


Inverter Switching Characteristics

figure 31. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

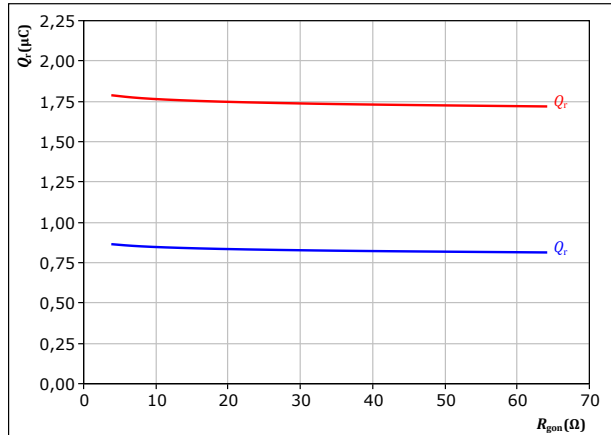
$V_{CE} = 400$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

T_j : — 25 °C
— 125 °C

figure 32. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

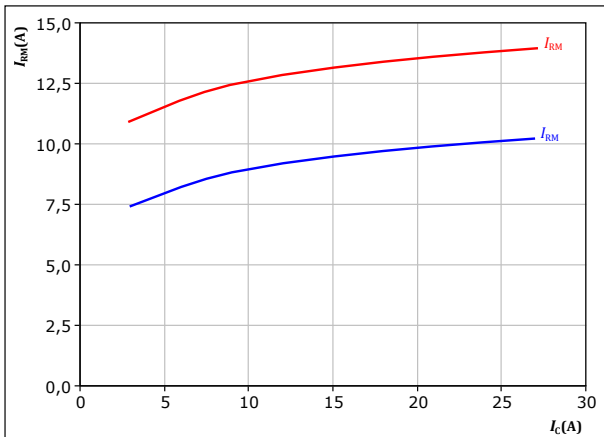
$V_{CE} = 400$ V
 $V_{GE} = \pm 15$ V
 $I_c = 15$ A

T_j : — 25 °C
— 125 °C

figure 33. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

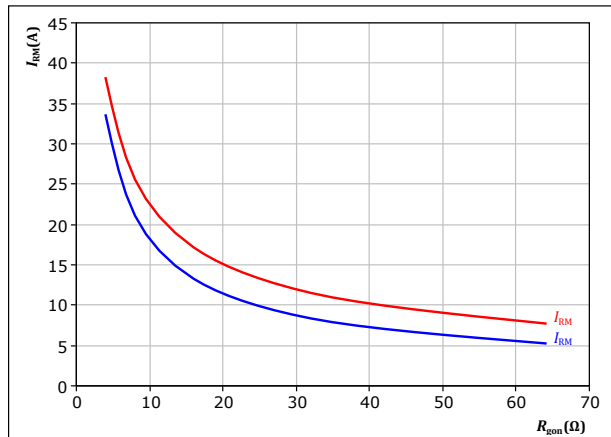
$V_{CE} = 400$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

T_j : — 25 °C
— 125 °C

figure 34. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = \pm 15$ V
 $I_c = 15$ A

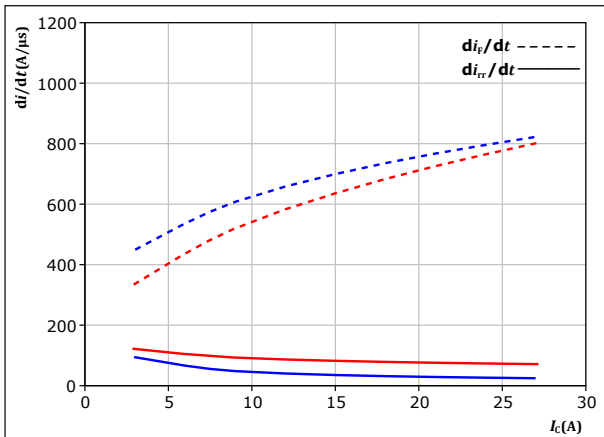
T_j : — 25 °C
— 125 °C



Inverter Switching Characteristics

figure 35. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



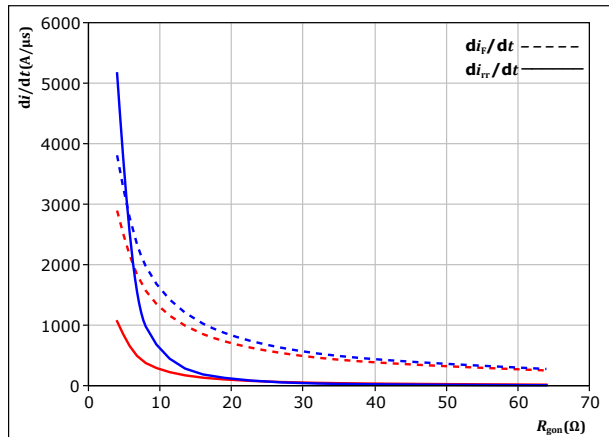
With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

T_j : — 25 °C
 — 125 °C

figure 36. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at

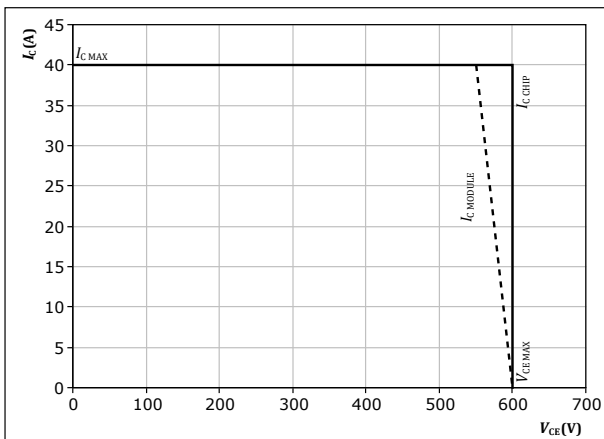
$V_{CE} = 400$ V
 $V_{GE} = \pm 15$ V
 $I_c = 15$ A

T_j : — 25 °C
 — 125 °C

figure 37. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



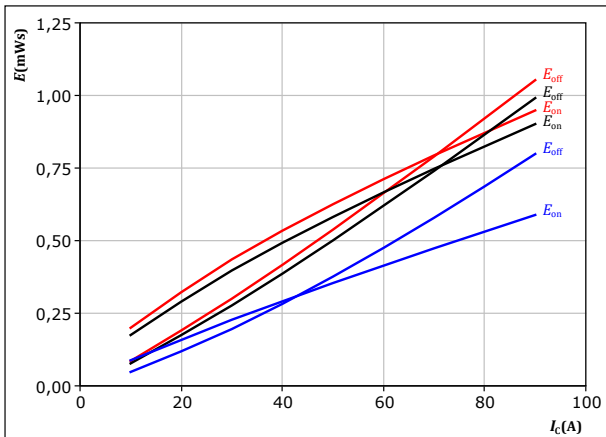
At $T_j = 125$ °C
 $R_{gon} = 16$ Ω
 $R_{goff} = 16$ Ω



PFC Switching Characteristics

figure 38. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$



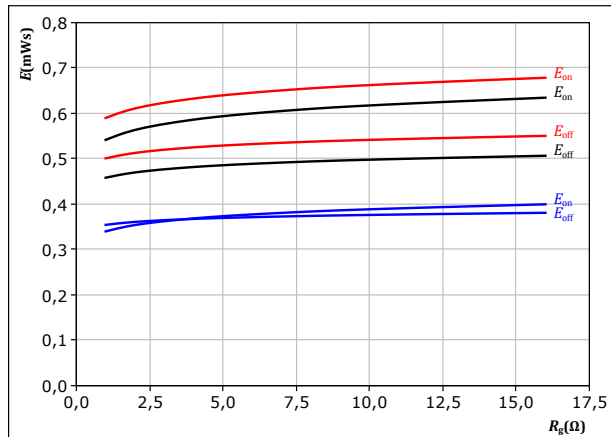
With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

T_j : — 25 °C
— 125 °C
— 150 °C

figure 39. IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor
 $E = f(R_g)$



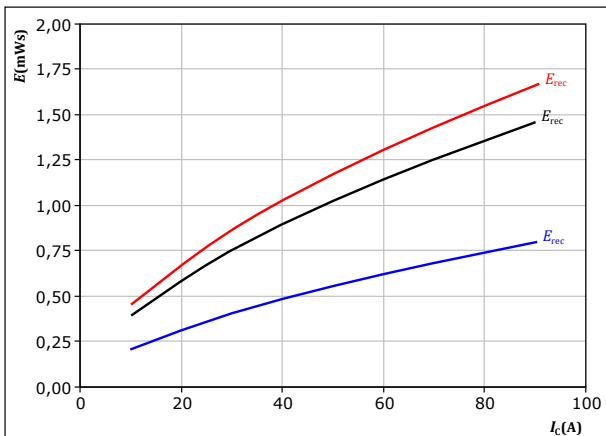
With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 50$ A

T_j : — 25 °C
— 125 °C
— 150 °C

figure 40. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$



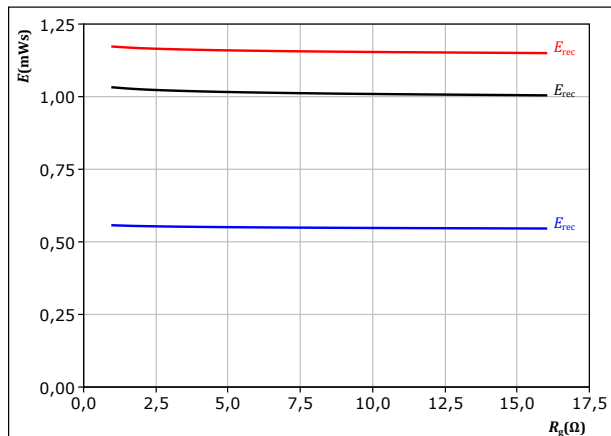
With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω

T_j : — 25 °C
— 125 °C
— 150 °C

figure 41. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 50$ A

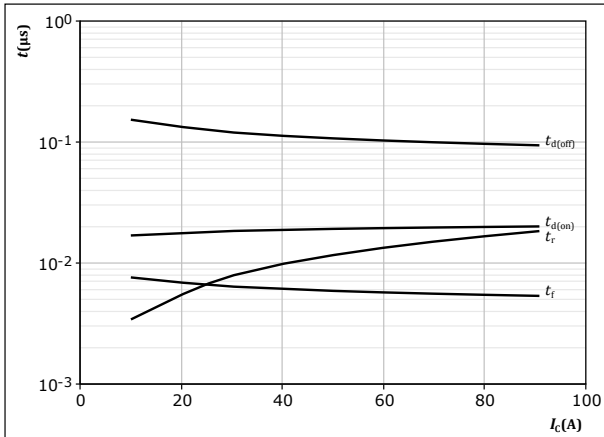
T_j : — 25 °C
— 125 °C
— 150 °C



PFC Switching Characteristics

figure 42. IGBT

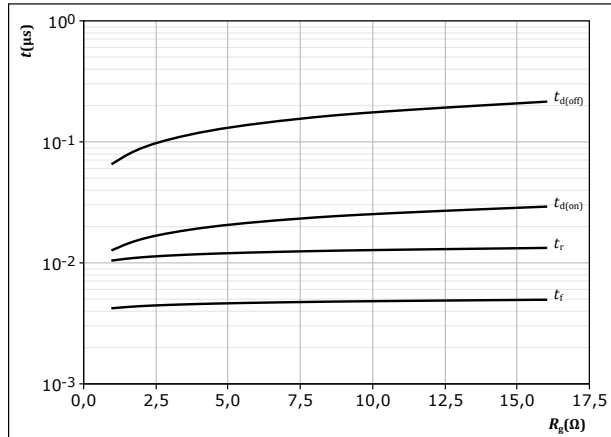
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 4 \text{ } \Omega$
 $R_{goff} = 4 \text{ } \Omega$

figure 43. IGBT

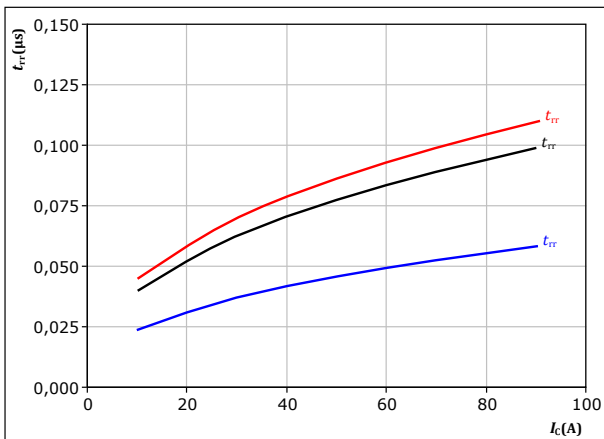
Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 50 \text{ A}$

figure 44. FWD

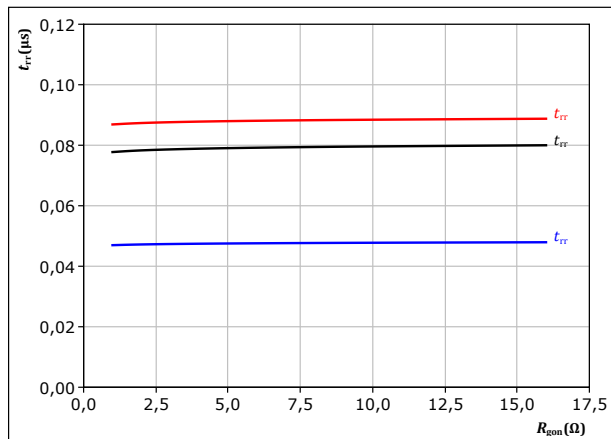
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 4 \text{ } \Omega$
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 45. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 50 \text{ A}$
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

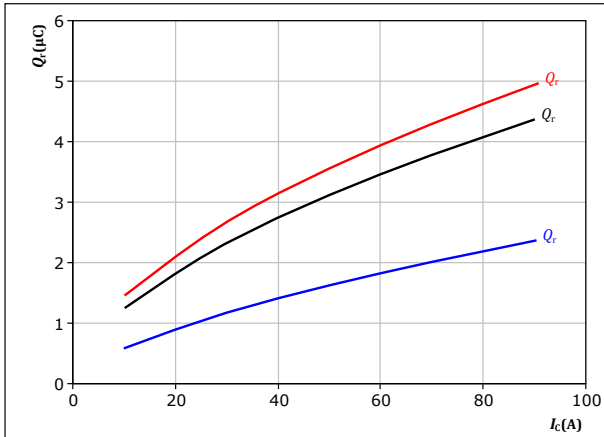


PFC Switching Characteristics

figure 46. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

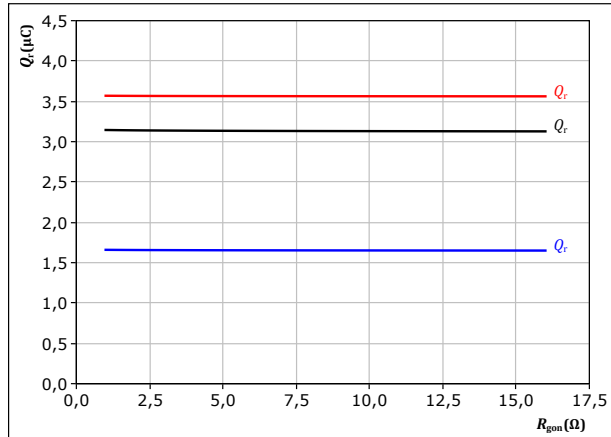
$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 4 \ \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 47. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

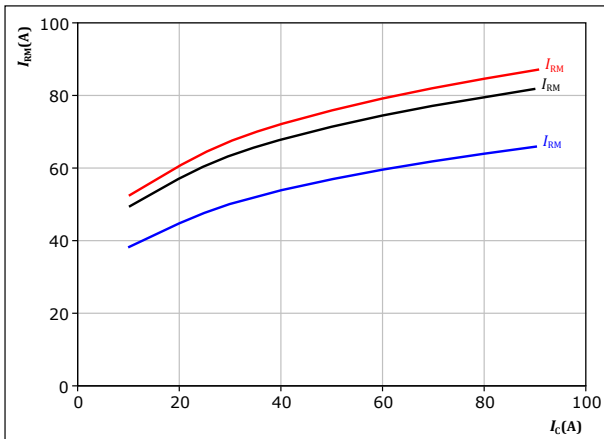
$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 50 \text{ A}$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 48. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

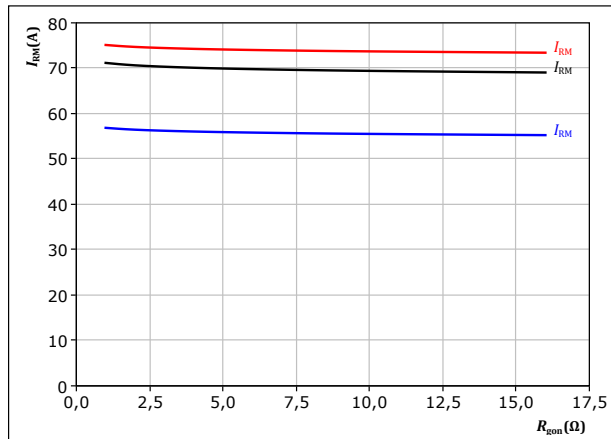
$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 4 \ \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 49. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 50 \text{ A}$

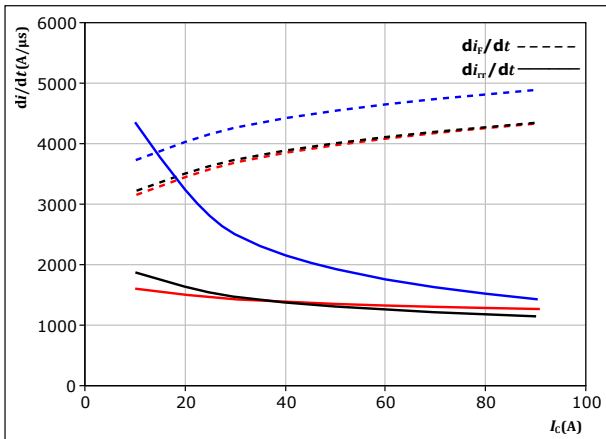
T_j : — 25 °C
— 125 °C
— 150 °C



PFC Switching Characteristics

figure 50. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_c)$



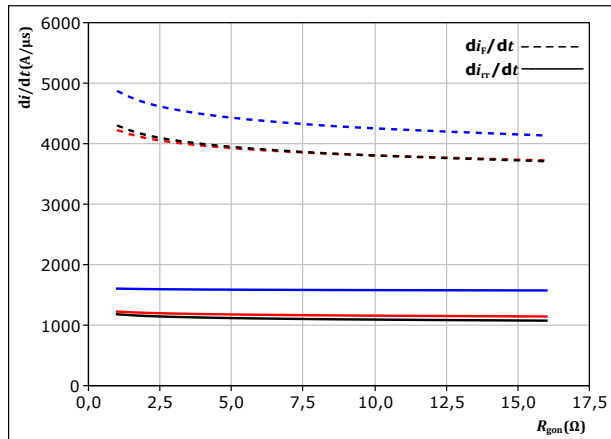
With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω

T_j : 25 °C
 125 °C
 150 °C

figure 51. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_r/dt = f(R_{gon})$



With an inductive load at

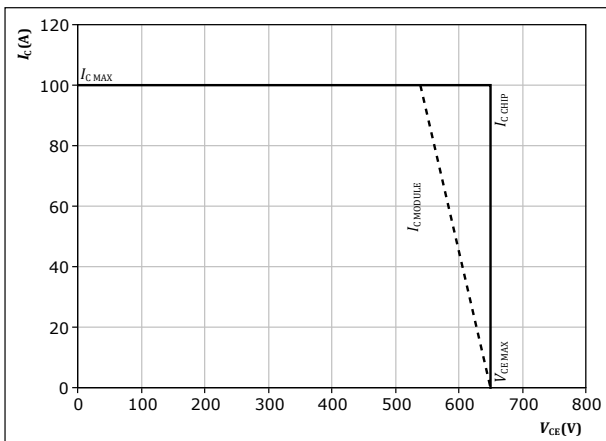
$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 50$ A

T_j : 25 °C
 125 °C
 150 °C

figure 52. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω



Switching Definitions

figure 53. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

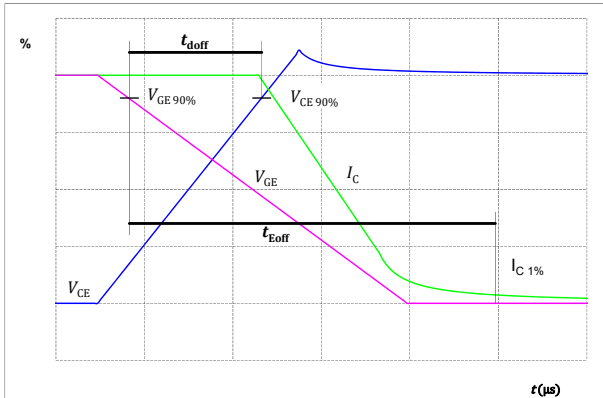


figure 54. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

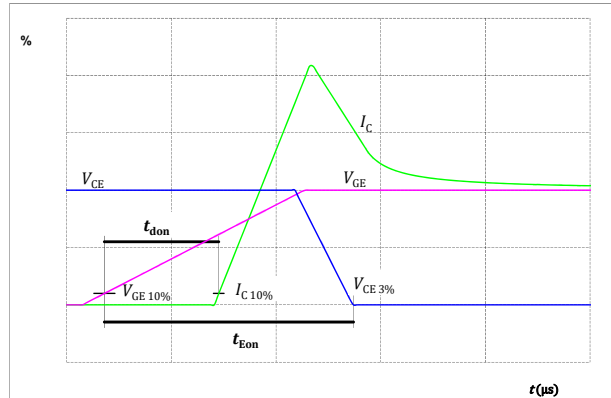


figure 55. IGBT

Turn-off Switching Waveforms & definition of t_f

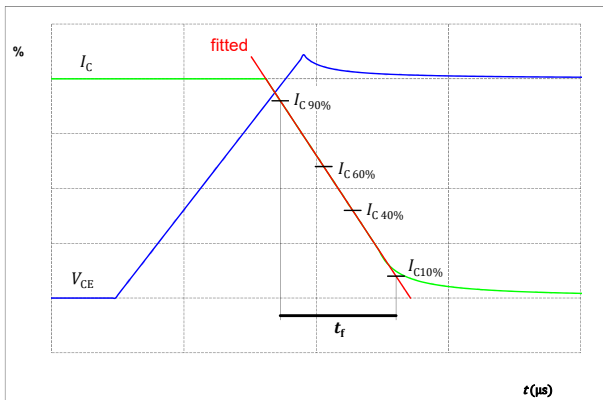
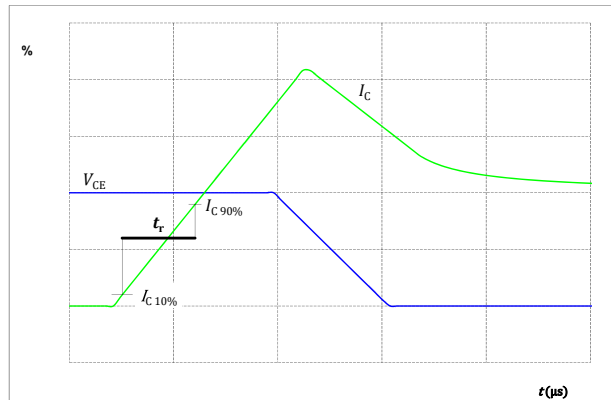


figure 56. IGBT

Turn-on Switching Waveforms & definition of t_r





Switching Definitions

figure 57. FWD

Turn-off Switching Waveforms & definition of t_{rr}

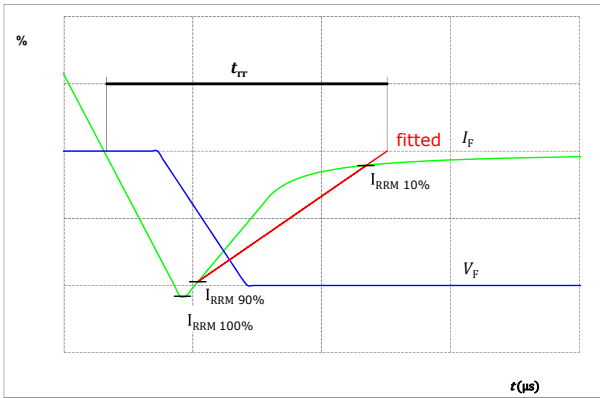
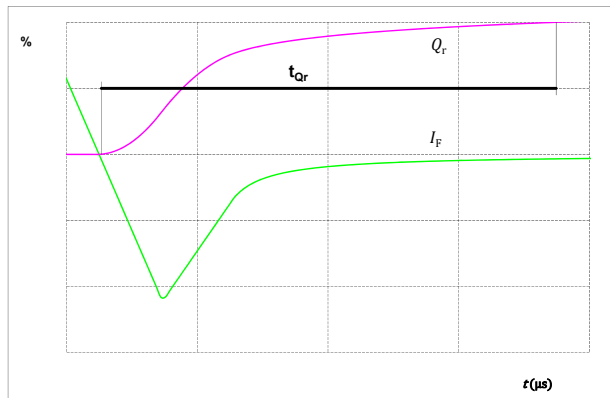


figure 58. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





10-P006PPA020SB02-M685B30Y

datasheet

Vincotech

Ordering Code	
Version	Ordering Code
Without thermal paste	10-P006PPA020SB02-M685B30Y
With thermal paste (5,2 W/mK, PTM6000HV)	10-P006PPA020SB02-M685B30Y-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-P006PPA020SB02-M685B30Y-/3/

Marking						
	Text	Name NN-NNNNNNNNNNNNNN- TTTTIV	Date code WWYY	UL & VIN UL VIN	Lot LLLLL	Serial SSSS
	Datamatrix	Type&Ver TTTTIV	Lot number LLLLL	Serial SSSS	Date code WWYY	

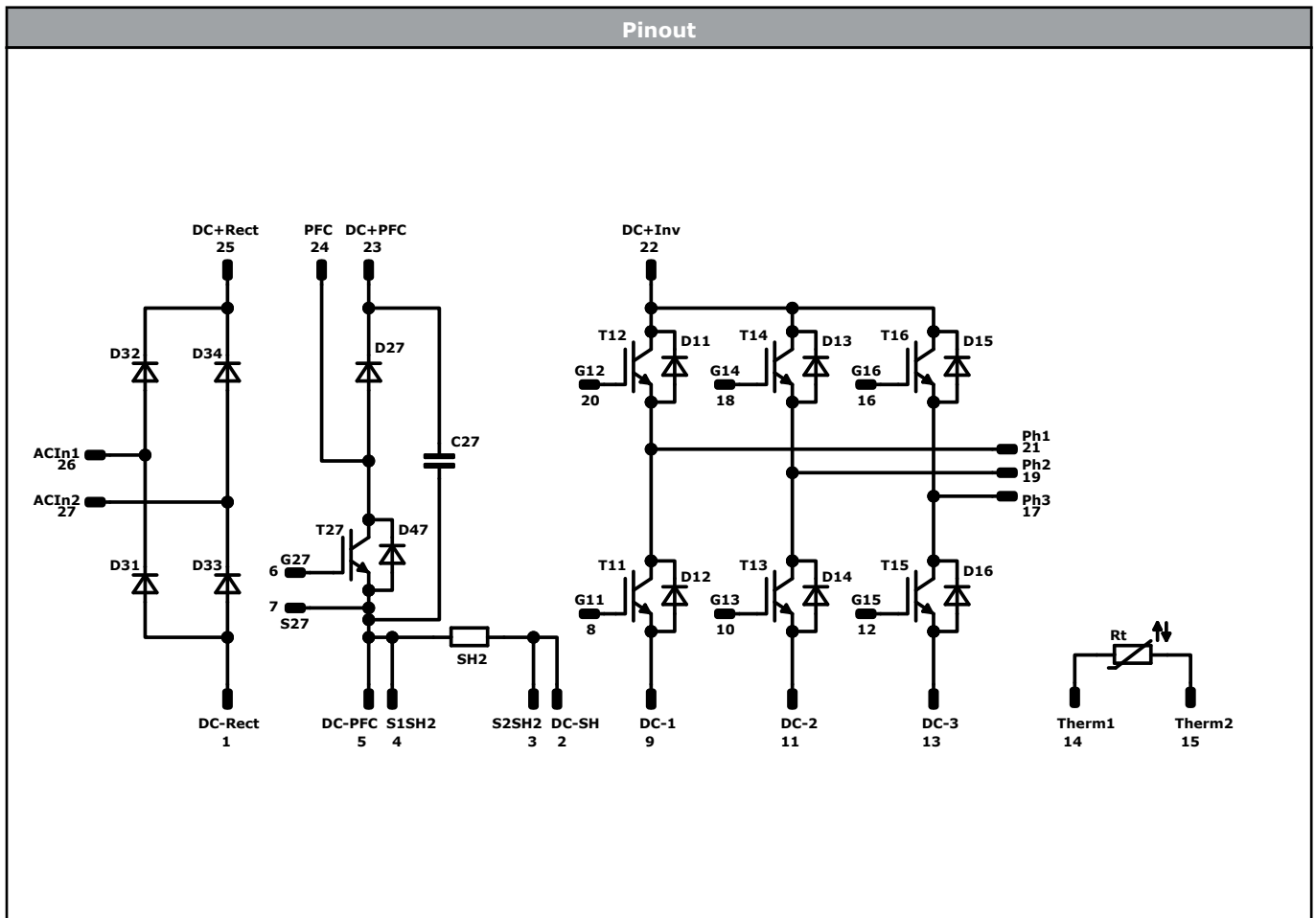
Pin table [mm]			
Pin	X	Y	Function
1	33,5	0	DC-Rect
2	30,7	0	DC-SH
3	28	0	S2SH2
4	25,3	0	S1SH2
5	22,6	0	DC-PFC
6	19,9	0	G27
7	17,2	0	S27
8	13,5	0	G11
9	10,8	0	DC-1
10	8,1	0	G13
11	5,4	0	DC-2
12	2,7	0	G15
13	0	0	DC-3
14	0	8,6	Therm1
15	0	11,45	Therm2
16	0	19,8	G16
17	0	22,5	Ph3
18	6	19,8	G14
19	6	22,5	Ph2
20	12	19,8	G12
21	12	22,5	Ph1
22	17,7	22,5	DC+INV
23	20,5	22,5	DC+PFC
24	26,5	22,5	PFC
25	33,5	22,5	DC+Rect
26	33,5	15	ACIn1
27	33,5	7,5	ACIn2

center of press-fit pinhead
for connection parameter see the handling instruction

Tolerance of pinposition: ±0,5mm at the end of pins.
Dimension of coordinate axis is only offset without tolerance.



Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	600 V	20 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	600 V	30 A	Inverter Diode	
T27	IGBT	650 V	50 A	PFC Switch	
D27	FWD	650 V	50 A	PFC Diode	
D47	FWD	650 V	6 A	PFC Sw. Inverse Diode	
D31, D32, D33, D34	Rectifier	1600 V	25 A	Rectifier Diode	
SH2	Shunt			PFC Shunt	
C27	Capacitor	500 V		Capacitor (PFC)	
Rt	Thermistor			Thermistor	




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Packaging instruction				
Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow 0</i> packages see vincotech.com website.

Package data
Package data for <i>flow 0</i> packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-P006PPA020SB02-M685B30Y-D3-14	8 Feb. 2024	Add alternative rectifier source	

DISCLAIMER

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Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.